

Applicant:

Smith et al

Serial No.:

10/775,718

Filed:

February 9, 2004

Customer No.:

33123

For:

METHOD AND APPARATUS FOR SELF-REFERENCED WAFER

STAGE POSITIONAL ERROR

**MAPPING** 

**CERTIFICATE OF MAILING** 

I hereby certify that this correspondence and the attached papers are being deposited with the United States Postal Service with sufficient postage as first class mail on the date indicated below in an envelope addressed to:

Commissioner for Patents

PO Box 1450

Alexandria, VA 22313-1450

### TRANSMITTAL LETTER

Commissioner for Patents PO Box 1450 Alexandria, Virginia 22313-1450

Sir:

Transmitted herewith are an Information Disclosure Statement and Form PTO-1449 (4 pages). Because this Information Disclosure Statement is filed prior to receipt of a first office action on the merits in the above-referenced application, no fee is due. However, should it be determined that a fee for filing these papers is required, the Commissioner is authorized to charge Deposit Account No. 05-1213, as stated below:

[X] The Commissioner is hereby authorized to charge any fees that may be due under 37 C.F.R. §§ 1.16-1.17 in connection with this paper or with this application during its entire pendency to Deposit Account No. 05-1213. A copy of this sheet is enclosed.

Respectfully submitted,

HELLER, EHRMAN, WHITE & McAULIFFE LLP

Registration No. 32,233

Attorney Docket No. 38203-6082B Address all correspondence to:

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Commissioner for Patents

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Alexandria, VA 22313-1450

INFORMATION DISCLOSURE STATEMENT **IN ACCORDANCE WITH 37 C.F.R. §§ 1.97-1.98** 

Commissioner for Patents P.O. Box 1450 Alexandria, Virginia 22313-1450

Sir:

Because this Information Disclosure Statement is filed prior to receipt of a First Office Action on the merits of the above-captioned application, a fee for filing this statement should not be due. If, however, it is determined that a fee is due, then any fees that may be due in connection with filing this paper may be charged to Deposit Account No. 50-1213.

In accordance with the duty of disclosure imposed by 37 C.F.R. § 1.56 to inform the Patent Office of all material references known by Applicant or Applicants' representative, this Information Disclosure Statement prepared in accordance with 37 C.F.R. §§ 1.97-1.98 is hereby submitted. Attached is a Form PTO-1449 (4 pages) for filing in connection with the above cited continuation application.

In accordance with 37 C.F.R. § 1.98(d), copies of the cited documents are not provided, as they have been previously provided in connection with the related case of U.S. Application Serial No. 09/891,699 filed June 26, 2001 on which this application relies (35 U.S.C. § 120) for an earlier effective filing date. The earlier-filed '699 Application claims benefit of priority to U.S. Provisional Application Serial No. 60/254,413 filed on December 8, 2000.

Although these documents and information are made known to the Patent and Trademark Office in compliance with Applicants' duty of disclosure, such disclosure is not to be construed as an admission by Applicants or Applicants' representative that any of the references, singly or in any combination thereof, is effective as prior art against the subject

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application. In accordance with 37 C.F.R. § 1.97(h), the filing of this Information Disclosure Statement shall not be construed to mean that a search has been made or that no other material information as defined in 37 C.F.R. § 1.56(b) exists.

Applicants respectfully request that the Examiner review the foregoing references and request that they be made of record in the file history of the above-captioned application.

Respectfully submitted, HELLER, EHRMAN, WHITE & McAULIFFE LLP

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SD 656935v1 (38203-6082)

UNDER 37 CFR §1.56, §1.97, and §1.98

PTO-1449 FORM

Sheet 1 of 4

ATTORNEY DOCKET NO.: 38203-6082B

SERIAL NO.: 10/775,718

APPLICANTS: Smith et al

FILING DATE: 02/09/04

**GROUP ART UNIT: Unknown** 

1	TRADENT		U.S	S. PATENT DOCUMENTS		
EX'R	*REF. #	PATENT NUMBER	DATE	NAME	U.S. CLASS/ SUBCLASS	FILING DATE
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		5,444,538	08/22/95	Pellegrini	356/401	
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		5,757,507	05/26/98	Ausschnitt et al.	356/401	
		5,805,290	09/08/98	Ausschnitt et al	256/401	
		5,824,441	10/20/98	Farrow et al	430/22	
		5,877,861	03/02/99	Ausschnitt et al.	356/401	
•		5,953,128	09/14/99	Ausschnitt et al	250/548	,
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		6,064,486	05/16/00	Chen et al	356/399	
_		6,079,256	06/27/00	Bareket	73/105	
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		6,218,200	04/17/01	Chen et al	356/399	
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EXAMINER'S SIGNATURE DATE CONSIDERED

<sup>†</sup> EXAMINER: Initial if reference is considered, whether or not citation is in conformance with MPEP 609. Line through citation if not in conformance and not considered. *Include copy of this form in next communication to applicant.* 

<sup>\*</sup> If an asterisk is placed beside the reference number, a copy is not provided because the reference was previously cited by or submitted to the PTO in a prior application that is identified in the statement and relied upon for an earlier filing date under 35 U.S.C. 120. 37 C.F.R. 1.98(d).

# **INFORMATION DISCLOSURE STATEMENT**

UNDER 37 CFR §1.56, §1.97, and §1.98

**PTO-1449 FORM** 

Sheet 2 of 4

ATTORNEY DOCKET	NO.:
38203-6082B	

SERIAL NO.: 10/775,718

APPLICANTS: Smith et al

FILING DATE: 02/09/04

GROUP ART UNIT: Unknown

FOREIGN PATENT DOCUMENTS									
†EX'R INITIAL	*REF. #				TRANSLATION (YES/NO)				
			N/A	N/A					
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				OTHER DOCUMENTS					
† EX'R INITIAL	*REF. #		CITATION (A	uthor, Article Title, Journal/Book Title, Date, Pertinent Pages, etc.)					
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# **INFORMATION DISCLOSURE STATEMENT**

UNDER 37 CFR §1.56, §1.97, and §1.98 **PTO-1449 FORM** 

Sheet 3 of 4

ATTORNEY DOCKET	NO.:
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# INFORMATION DISCLOSURE STATEMENT

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<b>ATTORNE</b>	Y I	DOCKET	NO.
38203-60	8	2B	

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APPLICANTS: Smith et al

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**GROUP ART UNIT: Unknown** 

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SD 656917 v1 (38203.6082)

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